



JMSH1507PC  
JMSH1507PE

## 150V 5.0mΩ N-Ch Power MOSFET

### Features

- Ultra-low  $R_{DS(ON)}$
- Low Gate Charge
- 100% UIS Tested, 100%  $R_g$  Tested
- Halogen-free and RoHS-compliant

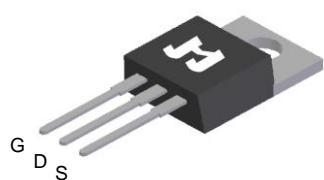
### Product Summary

Parameter	Value	Unit
$V_{DS}$	150	V
$V_{GS(th)}_{Typ}$	3.2	V
$I_D (@ V_{GS} = 10V)$ <sup>(1)</sup>	133	A
$R_{DS(ON)}_{Typ} (@ V_{GS} = 10V)$	5.0	mΩ

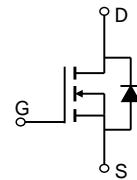
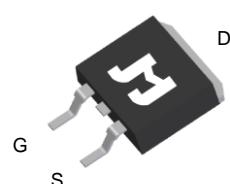
### Applications

- Power Management in Telecom., Industrial Automation, CE
- Current Switching in DC/DC & AC/DC (SR) Sub-systems
- Motor Driving in Power Tool, E-vehicle, Robotics

TO-220-3L Top View



TO-263-3L Top View



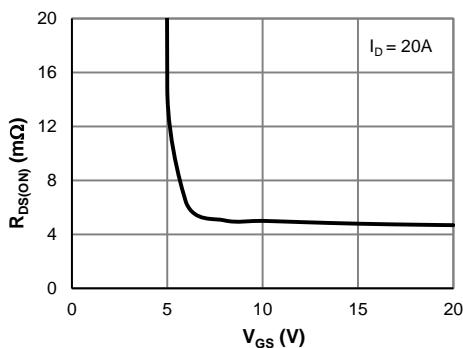
### Ordering Information

Device	Package	# of Pins	Marking	MSL	$T_J (°C)$	Media	Quantity (pcs)
JMSH1507PC-U	TO-220-3L	3	SH1507P	NA	-55 to 150	Tube	50
JMSH1507PE-13	TO-263-3L	3	SH1507P	3	-55 to 150	13-inch Reel	800

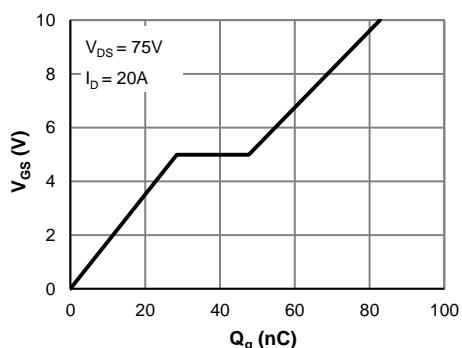
### Absolute Maximum Ratings (@ $T_A = 25°C$ unless otherwise specified)

Parameter	Symbol	Value		Unit
Drain-to-Source Voltage	$V_{DS}$	150		V
Gate-to-Source Voltage	$V_{GS}$	$\pm 20$		V
Continuous Drain Current <sup>(1)</sup>	$I_D$	133		A
$T_C = 100°C$		84		
Pulsed Drain Current <sup>(2)</sup>	$I_{DM}$	532		A
Avalanche Energy <sup>(3)</sup>	$E_{AS}$	1944		mJ
Power Dissipation <sup>(4)</sup>	$P_D$	240		W
$T_C = 100°C$		96		
Junction & Storage Temperature Range	$T_J, T_{STG}$	-55 to 150		°C

$R_{DS(ON)}$  vs.  $V_{GS}$



Gate Charge



Electrical Characteristics (@  $T_J = 25^\circ C$  unless otherwise specified)

Parameter	Symbol	Conditions	Min.	Typ.	Max.	Unit
<b>STATIC PARAMETERS</b>						
Drain-Source Breakdown Voltage	$V_{(BR)DSS}$	$I_D = 250\mu A, V_{GS} = 0V$	150			V
Zero Gate Voltage Drain Current	$I_{DSS}$	$V_{DS} = 120V, V_{GS} = 0V$ $T_J = 55^\circ C$			1.0 5.0	$\mu A$
Gate-Body Leakage Current	$I_{GSS}$	$V_{DS} = 0V, V_{GS} = \pm 20V$			$\pm 100$	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS} = V_{GS}, I_D = 250\mu A$	2.5	3.2	4.5	V
Static Drain-Source ON-Resistance	$R_{DS(ON)}$	$V_{GS} = 10V, I_D = 20A$ TO-263-3L TO-220-3L		5.0 5.2	6.0 6.2	$m\Omega$
Forward Transconductance	$g_{FS}$	$V_{DS} = 5V, I_D = 20A$		51		S
Diode Forward Voltage	$V_{SD}$	$I_S = 1A, V_{GS} = 0V$		0.70	1.0	V
Diode Continuous Current	$I_S$	$T_C = 25^\circ C$			133	A
<b>DYNAMIC PARAMETERS (5)</b>						
Input Capacitance	$C_{iss}$	$V_{GS} = 0V, V_{DS} = 75V, f = 1MHz$		5800		pF
Output Capacitance	$C_{oss}$			557		pF
Reverse Transfer Capacitance	$C_{rss}$			16.8		pF
Gate Resistance	$R_g$	$V_{GS} = 0V, V_{DS} = 0V, f = 1MHz$		3.8		$\Omega$
<b>SWITCHING PARAMETERS (5)</b>						
Total Gate Charge (@ $V_{GS} = 10V$ )	$Q_g$	$V_{GS} = 0$ to $10V$ $V_{DS} = 75V, I_D = 20A$		83		nC
Total Gate Charge (@ $V_{GS} = 6V$ )	$Q_g$			53		nC
Gate Source Charge	$Q_{gs}$			28		nC
Gate Drain Charge	$Q_{gd}$			19.2		nC
Turn-On DelayTime	$t_{D(on)}$	$V_{GS} = 10V, V_{DS} = 75V$ $R_L = 3.75\Omega, R_{GEN} = 3\Omega$		21		ns
Turn-On Rise Time	$t_r$			39		ns
Turn-Off DelayTime	$t_{D(off)}$			63		ns
Turn-Off Fall Time	$t_f$			32		ns
Body Diode Reverse Recovery Time	$t_{rr}$	$I_F = 15A, dI_F/dt = 100A/\mu s$		98		ns
Body Diode Reverse Recovery Charge	$Q_{rr}$	$I_F = 15A, dI_F/dt = 100A/\mu s$		316		nC

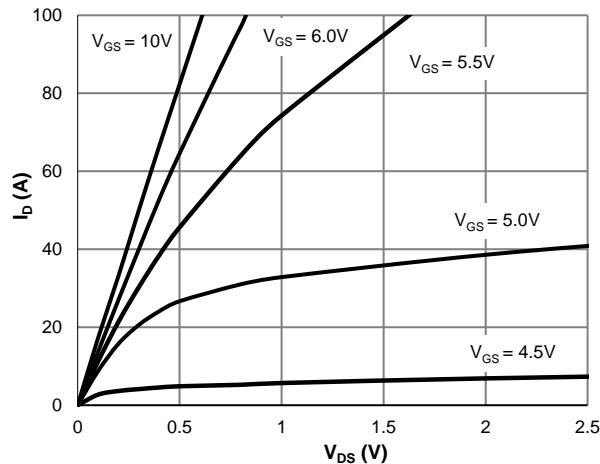
## Thermal Performance

Parameter	Symbol	Typ.	Max.	Unit
Thermal Resistance, Junction-to-Ambient	$R_{0JA}$	45	55	$^\circ C/W$
Thermal Resistance, Junction-to-Case	$R_{0JC}$	0.52	0.65	$^\circ C/W$

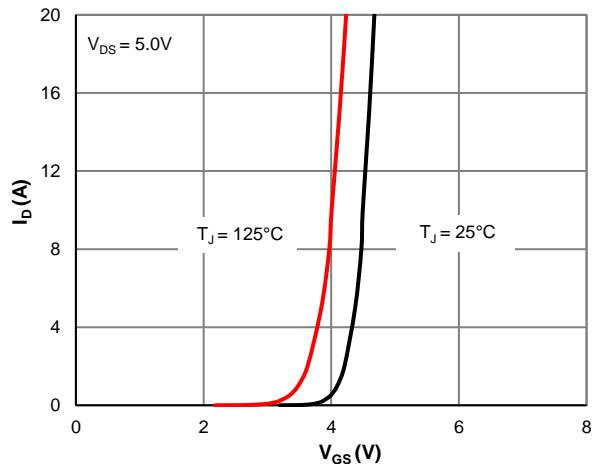
## Notes:

1. Computed continuous current assumes the condition of  $T_{J_{Max}}$  while the actual continuous current depends on the thermal & electro-mechanical application board design.
2. This single-pulse measurement was taken under  $T_{J_{Max}} = 150^\circ C$ .
3.  $E_{AS}$  of 864 mJ is based on starting  $T_J = 25^\circ C$ ,  $L = 3mH$ ,  $I_{AS} = 36A$ ,  $V_{GS} = 10V$ ,  $V_{DD} = 75V$ ; 100% test at  $L = 0.1mH$ ,  $I_{AS} = 131A$ .
4. The power dissipation  $P_D$  is based on  $T_{J_{Max}} = 150^\circ C$ .
5. This value is guaranteed by design hence it is not included in the production test.

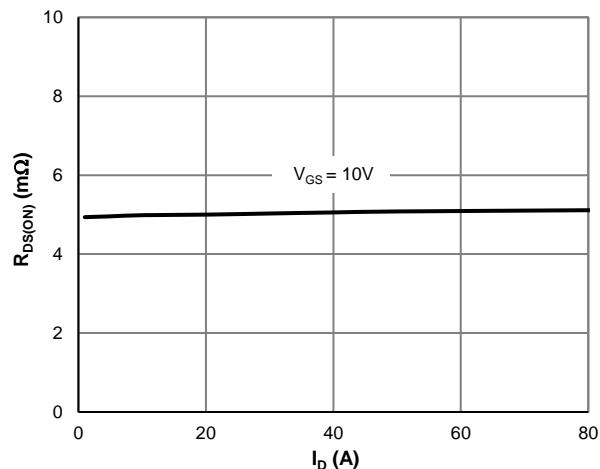
### Typical Electrical & Thermal Characteristics



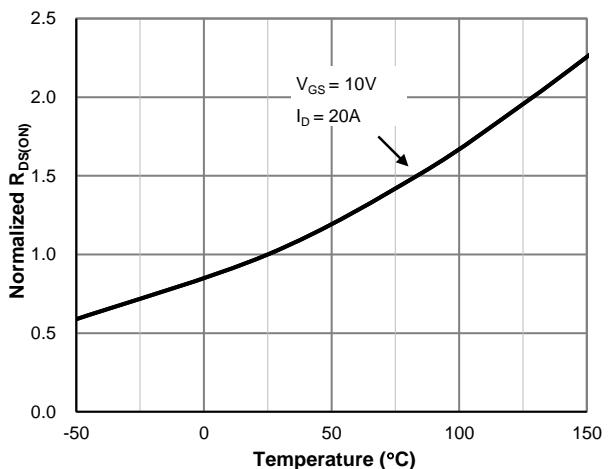
**Figure 1: Saturation Characteristics**



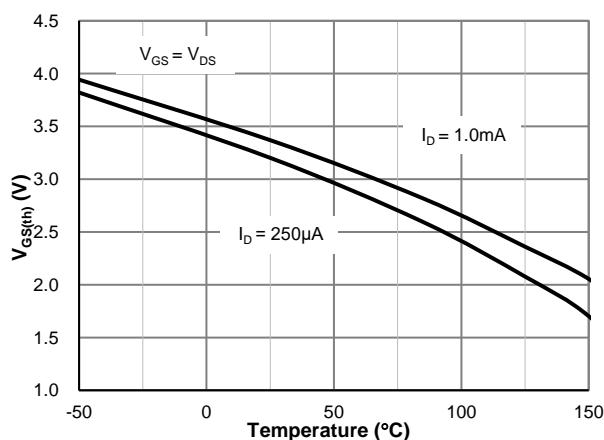
**Figure 2: Transfer Characteristics**



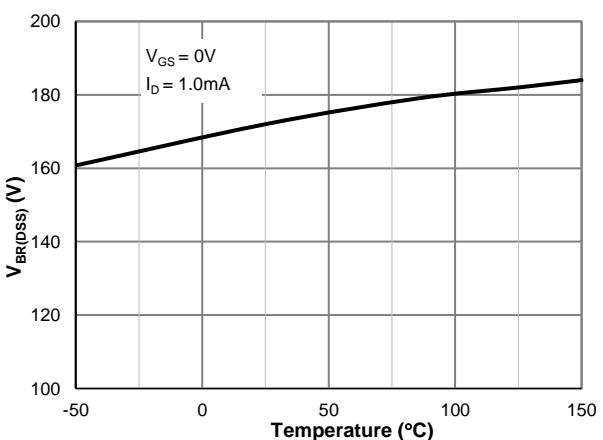
**Figure 3:  $R_{DS(ON)}$  vs. Drain Current**



**Figure 4:  $R_{DS(ON)}$  vs. Junction Temperature**



**Figure 5:  $V_{GS(th)}$  vs. Junction Temperature**



**Figure 6:  $V_{BR(DSS)}$  vs. Junction Temperature**

### Typical Electrical & Thermal Characteristics

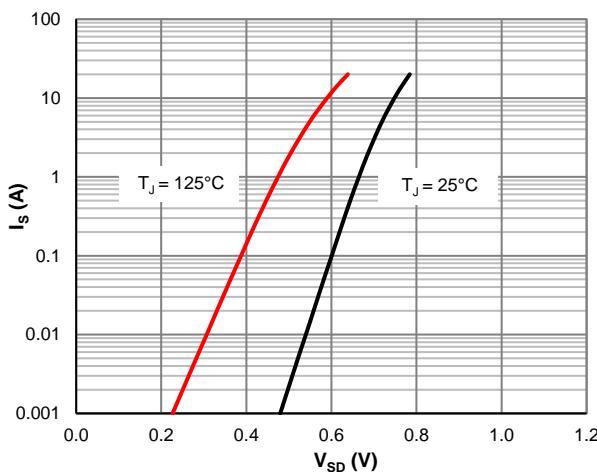


Figure 7: Body-Diode Characteristics

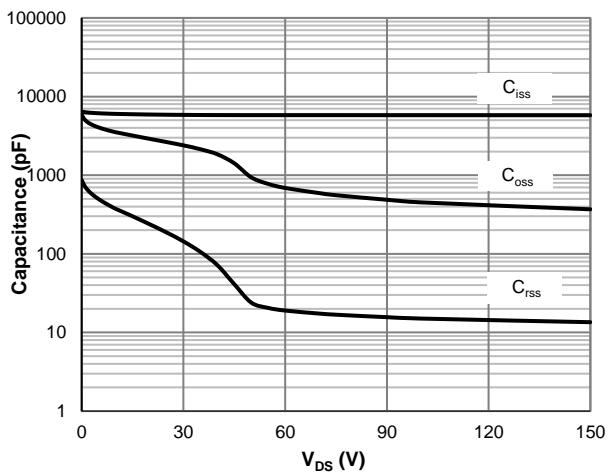


Figure 8: Capacitance Characteristics

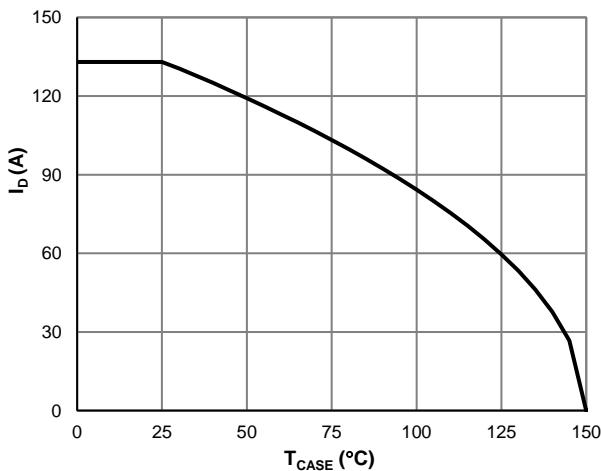


Figure 9: Current De-rating

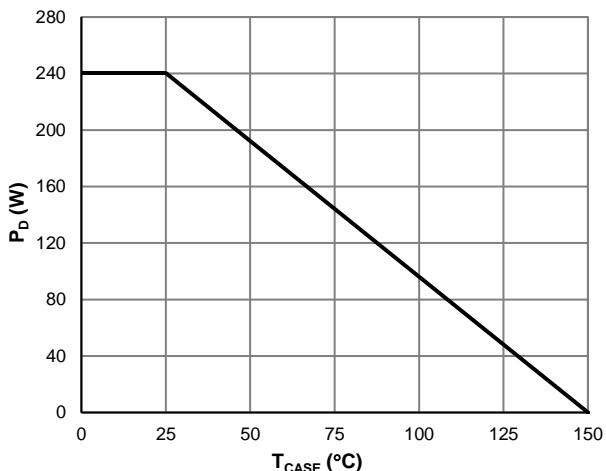


Figure 10: Power De-rating

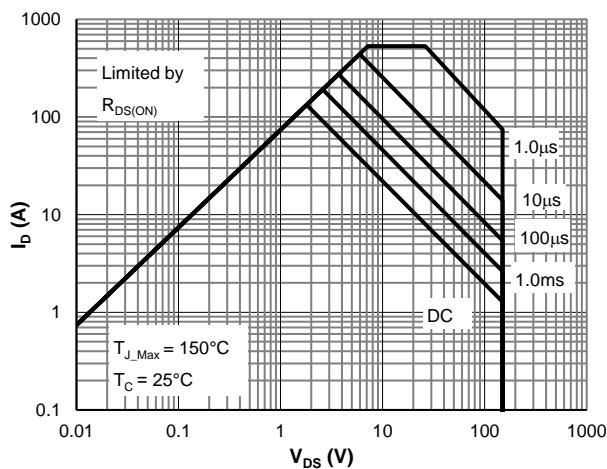


Figure 11: Maximum Safe Operating Area

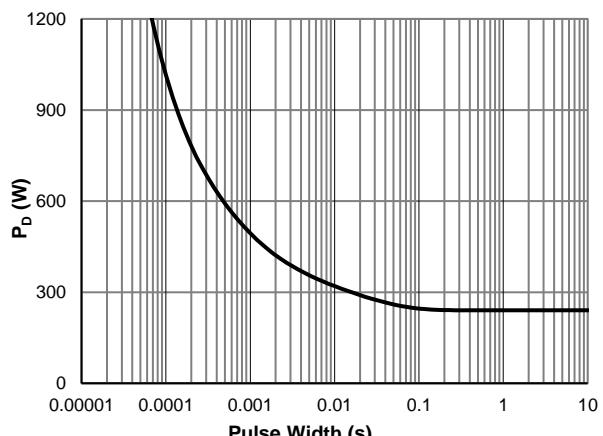


Figure 12: Single Pulse Power Rating, Junction-to-Case

## Typical Electrical &amp; Thermal Characteristics

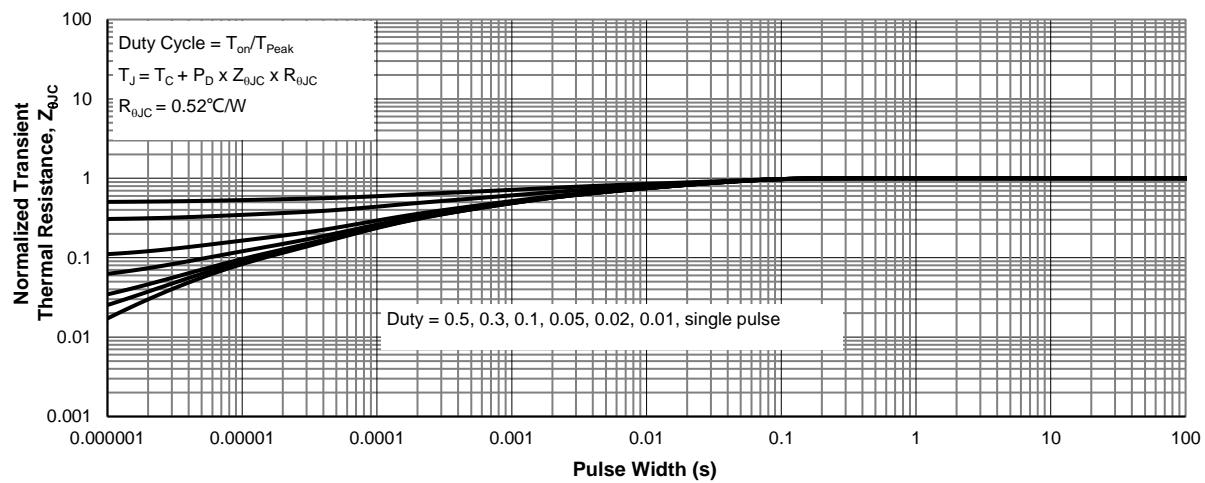
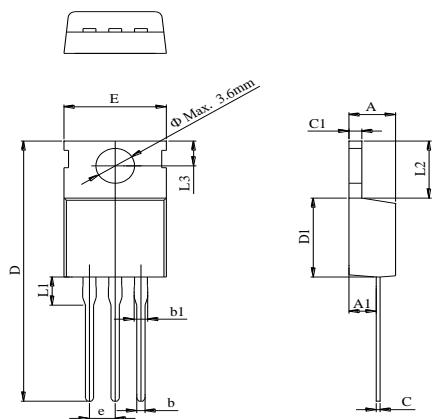


Figure 13: Normalized Maximum Transient Thermal Impedance

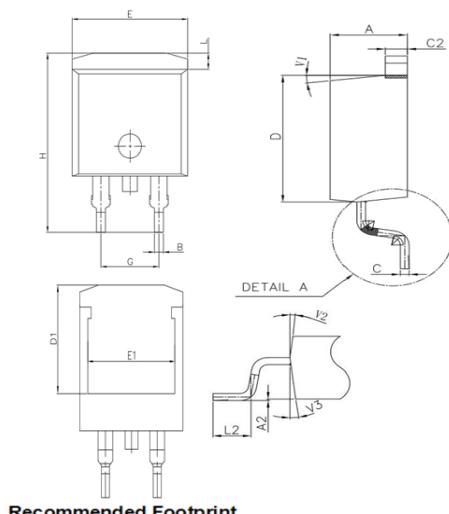
### TO-220-3L Package Information

Package Outline



DIM.	MILLIMETER		
	MIN.	NOM.	MAX.
A	4.24		4.70
A1	2.20		3.00
b	0.70		0.95
b1	1.14		1.70
C	0.40		0.60
C1	1.15		1.40
D	28.00		29.80
D1	8.80		9.90
E	9.70		10.50
L1			3.80
L2	6.25		6.90
L3	2.40		3.00
e		2.54 BSC	

### TO-263-3L Package Information



Recommended Footprint

SYMBOL	DIMENSIONS		
	MIN	NOM	MAX
A	4.3	4.55	4.7
A2	0		0.15
B	0.75	0.8	0.85
C	0.38	0.46	0.55
C2	1.25	1.3	1.35
D	8.9	9.3	9.6
D1	7.4	7.65	7.9
E	9.9	10.05	10.21
E1	8.3	8.6	8.9
G	5.03	5.08	5.13
H	14.7	15	15.8
L2	2.2	2.35	2.5

